## HF361-65

### HiFluor Fluoroelastomer for Semiconductor Applications

Parker HiFluor Compound HF361-65 is a tan colored highly fluorinated, chemically resistant material that acts as a lower cost suitable replacement to FFKM in select Semiconductor processes. In applications such as etching, deposition, and gas transfer HF369-80 has comparable performance to competitive FFKMs. Incorporating HiFluor materials can significantly reduce the total cost of ownership of semiconductor manufacturing.

This lower durometer material is intended to make installation easier for O-rings and other seal types into tighter groove shapes, such as dovetails and radius corner designs. It can relieve some pressure on somewhat sensitive hardware. HF361-65 seals can be compressed with lower closure forces than other fluoroelastomers for improved reliability and sealing performance.



Outstanding chemical resistance, low outgassing, low particle generation, etch resistance, wet bench chemistries, applications where FFKM may be overengineered.

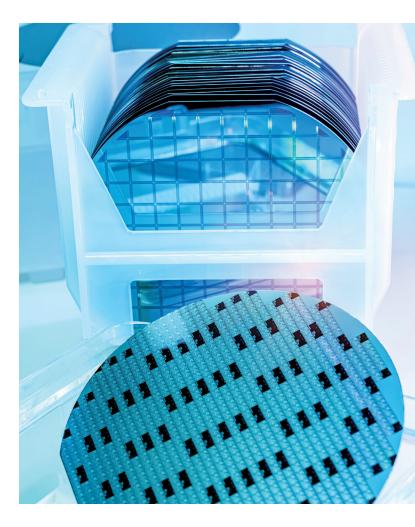
#### Recommended Temperature Range:

-15°F to 400°F (-26°C to 204°C)

#### Features & Benefits:

- Outstanding high purity
- Very low particle generation and ion content
- Cost effective alternative to FFKM
- Good chemical/plasma resistance
- Improved cleanliness compared to fluorocarbon (FKM)
- Performance up to 204°C/400°F
- Products include 0-rings, molded shapes, and bonded product





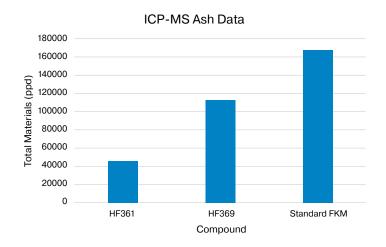


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| Original Physical Properties                                 | Test       | Results |
|--|------------|---------|
| Hardness, Shore A, pts.                                      | ASTM D2240 | 70      |
| Tensile Strength, psi  | ASTM D1414 | 977     |
| Ultimate Elongation, %                                       | ASTM D1414 | 214     |
| Modulus @ 100% Elongation, psi                               | ASTM D1414 | 295     |
| Specific Gravity   | ASTM D297  | 1.87    |
| Compression Set  | Test       | Results |
| 22 hrs @ 392°F (200°C)                                       | ASTM D395  | 19      |
| 70 hrs @ 392°F (200°C)                                       | Method B   | 34      |
| 168 hrs @ 392°F (200°C)                                      |            | 54      |
| Compression Set  | Test       | Results |
| 22 hrs @ 446°F (230°C)                                       | ASTM D395  | 31      |
| 70 hrs @ 446°F (230°C)                                       | Method B   | 54      |
| 168 hrs @ 446°F (230°C)                                      |            | 93      |
| Chemical Compatibility                                       | Test       | Results |
| C <sub>4</sub> H <sub>8</sub> O (MEK), 70 hrs<br>@ Room Temp | ASTM D471  |         |
| Hardness Change, pts.  | Method B   | 35      |
| Tensile Strength Change, psi                                 |            | 78      |
| Ultimate Elongation Change, %                                |            | 40      |
| Volume Change, %   |            | 188     |
| Heat Age   | Test       | Results |
| 70 hrs @ 446°F (230°C)                                       | ASTM D471  |         |
| Hardness change, pts.  |            | 5       |
| Tensile Strength Change, psi                                 |            | 8       |
| Ultimate Elongation Change, %                                |            | 1       |

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